**F A Q**

### 1. How to solve the problem that the filament cannot stick to the build bed?

Leveling, reducing the speed of the first layer, adjusting the temperature or cooling settings (including platform temperature, nozzle temperature, generally increasing the platform temperature, reducing or turning off the cooling fan), platform surface treatment (film, glue, etc.), plus skirt Or the base.

### 2. How to avoid tangle?

Pass the filament through the fixing hole and tighten it immediately after use.

### 3. How to avoid warping?

If printing large-size parts with a certain thickness, especially materials such as ABS, PA, PC, etc., a printer with a certain cavity temperature is required.

### 4. The printing surface is rough?

Generally, it is solved from three angles of printer, material, and slice setting.

It can be checked and judged according to the following points:

* Check the operating conditions of the printer, whether it is easy to jitter or stagger;
* Check whether the consumables are damp or the wire diameter is severely uneven-the consumables are severely damp, which will cause small holes on the surface of the print due to air bubbles, accompanied by wire drawing problems, and poor gloss;
* If it is judged that it is not the problem of the printer and the material, it can be adjusted by changing the layer thickness, extrusion volume, printing temperature and speed by slicing.